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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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# GHz Noise Suppression Chip Ferrite Bead BLM18H BLM18H

#### 1. Scope

This reference specification applies to Chip Ferrite Bead BLM18H\_SN Series.

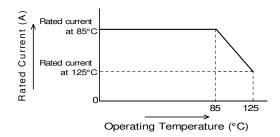
2. Part Numbering

(1)Product ID (2)Type (3)Dimension(L×W) (4)Characteristics (5)Typical Impedance at 100MHz (6)Performance (7)Category (8)Numbers of Circuit (9)Packaging(D:Taping / B:Bulk)

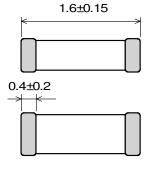
3. Rating									
Customer	MURATA	Imp (Under Standa	edance $(\Omega)$ ard Testing Co	ondition)		Current nA)		sistance nax.)	Damade
Part Number	Part Number Part Number	at 100MHz	at 1G	Hz Typical	at 85℃	at 125°C	Initial Values	Values After Testing	Remark
	BLM18HE601SN1D BLM18HE601SN1B	600±25%	300 min.	600	*1 800	*1 600	0.25	0.30	
	BLM18HE102SN1D BLM18HE102SN1B	1000±25%	500 min.	1000	*1 600	*1 500	0.35	0.40	For Large
	BLM18HE152SN1D BLM18HE152SN1B	1500±25%	750 min.	1500	*1 500	*1 400	0.50	0.55	Current
	BLM18HG471SN1D BLM18HG471SN1B	470±25%	400 min.	600		200	0.85	0.95	
	BLM18HG601SN1D BLM18HG601SN1B	600±25%	450 min.	700		200	1.0	1.1	For general
	BLM18HG102SN1D BLM18HG102SN1B	1000±25%	750 min.	1000		100	1.6	1.7	use
	BLM18HD471SN1D BLM18HD471SN1B	470±25%	700 min.	1000		100	1.2	1.3	
	BLM18HD601SN1D BLM18HD601SN1B	600±25%	850 min.	1200		100	1.5	1.6	
	BLM18HD102SN1D BLM18HD102SN1B	1000±25%	1100 min.	1700		50	1.8	1.9	For
	BLM18HB121SN1D BLM18HB121SN1B	120±25%	500±	40%		200	0.5	0.6	high speed signal line
	BLM18HB221SN1D BLM18HB221SN1B	220±25%	1100±	40%		100	0.8	0.9	
	BLM18HB331SN1D BLM18HB331SN1B	330±25%	1600±	40%		50	1.2	1.3	
	BLM18HK331SN1D BLM18HK331SN1B	330±25%	400±	40%		200	0.5	0.6	
	BLM18HK471SN1D BLM18HK471SN1B	470±25%	600±	40%		200	0.7	0.8	For
	BLM18HK601SN1D BLM18HK601SN1B	600±25%	700±	40%	100 0.9		1.0	Digital Interface	
	BLM18HK102SN1D BLM18HK102SN1B	1000±25%	1200±	40%		50	1.5	1.6	

<sup>•</sup> Operating Temperature : -55°C to +125°C • Storage Temperature : -55°C to +125°C

(Note) As for the Rated current marked with \*1, Rated Current is derated as right figure depending on the operating temperature.



#### 4. Style and Dimensions

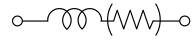






(in mm)

■ Equivalent Circuit



Resistance element becomes dominant at high frequencies.

Unit Mass (Typical value) 0.005g

#### 5. Marking

No marking.

#### 6. Standard Testing Conditions

< Unless otherwise specified >

Temperature : Ordinary Temp. (15 °C to 35 °C ) Humidity : Ordinary Humidity (25%(RH) to 85%(RH))

< In case of doubt >

Temperature : 20°C±2 °C Humidity : 60%(RH) to 70%(RH)

Atmospheric pressure: 86kPa to 106kPa

#### 7. Specifications

#### 7-1. Electrical Performance

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No.	Item	Specification	Test Method	
7-1-1	Impedance	Meet item 3.	Measuring Frequency: 100MHz±1MHz, 1GHz±1MHz Measuring Equipment: Agilent 4291A or the equivalent	
			Test Fixture : Agilent 16192A or the equivalent	
7-1-2	DC Resistance	Meet item 3.	Measuring Equipment : Digital multi meter	

#### 7-2. Mechanical Performance

1 -2. IVIE	2. Mechanical Feriorniance				
No.	Item	Specification	Test Method		
7-2-1	Appearance and Dimensions	Meet item 4.	Visual Inspection and measured with Slide Calipers.		
7-2-2	Bonding Strength	Meet Table 1.  Table 1  Appearance No damage Impedance Change (at 100MHz)  DC Resistance Within ±30%  Meet item 3.	It shall be soldered on the substrate.  Applying Force(F): 6.8N  Applying Time: 5s±1s  Applied direction:Parallel to substrate  Side view		

No.	Item	Specification	Test Method
7-2 - 3	Bending	Meet Table 1.	It shall be soldered on the substrate.
	Strength		Substrate: Glass-epoxy 100mm×40mm×1.0mm
			Deflection: 2.0mm
			Speed of Applying Force : 0.5mm/s
			Keeping Time: 30s Pressure jig
			R340 F Deflection
			Ψ
			45mm 45mm Product
7-2 - 4	Vibration		It shall be soldered on the substrate.
			Oscillation Frequency: 10Hz to 55Hz to 10Hz for 1 min
			Total Amplitude: 1.5mm
			Testing Time: A period of 2 hours in each of 3 mutually
	_		perpendicular directions. (Total 6 h)
7-2-5	Resistance		Pre-Heating: 150°C±10°C, 60s ~ 90s
	to Soldering		Solder: Sn-3.0Ag-0.5Cu
	Heat		Solder Temperature: 270°C±5°C
			Immersion Time: 10s±0.5s
			Immersion and emersion rates: 25mm/s
			Then measured after exposure in the room condition for 48h±4h.
7-2 - 6	Drop	Products shall be no failure	It shall be dropped on concrete or steel board.
		after tested.	Method : free fall
			Height: 75cm
			Attitude from which the product is dropped: 3 direction
			The number of times: 3 times for each direction
			(Total 9 times)
7-2-7	Solderability	The electrodes shall be at	Flux: Ethanol solution of rosin,25(wt)%
		least 95% covered with new	Pre-Heating: 150°C±10°C, 60s ~ 90s
		solder coating.	Solder: Sn-3.0Ag-0.5Cu
			Solder Temperature : 240°C±5°C
			Immersion Time : 3s±1s
			Immersion and emersion rates : 25mm/s

#### 7-3. Environmental Performance

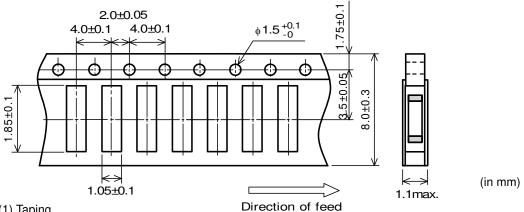
It shall be soldered on the substrate.

No.	Item	Specification	Test Method
7-3-1	Temperature Cycle	Meet Table 1.	1 cycle: 1 step:-55 °C(+0 °C,-3 °C) / 30min±3min 2 step:Ordinary temp. / 10min to 15min 3 step:+125 °C(+3 °C,-0 °C) / 30min±3min 4 step: Ordinary temp. / 10min to 15min Total of 100 cycles Then measured after exposure in the room condition for 48h±4h.
7-3-2	Humidity		Temperature: 40°C±2°C Humidity: 90%(RH) to 95%(RH) Time: 1000h(+48h,-0h) Then measured after exposure in the room condition for 48h±4h.

No.	Item	Specification	Test Method
7-3-3	Heat Life	Meet Table 2.  Table 2  Appearance No damage Impedance Within ±30% (for BLM18HE (at 100MHz) Within ±40%) DC Resistance Meet item 3.	Temperature: 125°C±3°C Applying Current: Rated Current (at 125°C) Time: 1000h(+48h,-0h) Then measured after exposure in the room condition for 48h±4h.
7-3-4	Cold Resistance	Meet Table 1.	Temperature: -55±2°C Time: 1000h(+48h,-0h) Then measured after exposure in the room condition for 48h±4h.

#### 8. Specification of Packaging

8-1. Appearance and Dimensions (8mm-wide paper tape)



(1) Taping

Products shall be packaged in the cavity of the base tape of 8mm-wide,4mm-pitch continuously and sealed by top tape and bottom tape.

(2) Sprocket hole

The sprocket holes are to the right as the tape is pulled toward the user.

(3) Spliced point

The base tape and top tape have no spliced point

(4) Cavity

There shall not be burr in the cavity.

(5) Missing components number

Missing components number within 0.1% of the number per reel or 1 pc., whichever is greater, and are not continuous. The specified quantity per reel is kept.

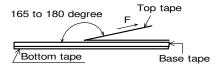
#### 8-2. Tape Strength

(1) Pull Strenath

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	Top tape	EN
	Bottom tape	5N min.

(2) Peeling off force of Top tape

0.1N to 0.6N (Minimum value is typical.) \*Speed of Peeling off:300mm/min



#### 8-3. Taping Condition

(1) Standard quantity per reel

Quantity per 180mm reel: 4000 pcs. / reel

- (2) There shall be leader-tape (top tape and empty tape) and trailer- tape(empty tape) as follows.
- (3) On paper tape, the top tape and the base tape shall not be adhered at the tip of the empty leader tape for more than 5 pitch.

#### (4) Marking for reel

The following items shall be marked on a label and the label is stuck on the reel. (Customer part number, MURATA part number, Inspection number(\*1), RoHS marking (\*2), Quantity, etc)

\*1) « Expression of Inspection No. »  $\frac{\Box \Box}{(1)} \frac{OOOO}{(2)} \frac{\times \times \times}{(3)}$ 

(1) Factory Code

(2) Date First digit : Year / Last digit of year

Second digit : Month / Jan. to Sep.  $\rightarrow$  1 to 9, Oct. to Dec.  $\rightarrow$  O, N, D

Third, Fourth digit: Day

(3) Serial No.

\*2) « Expression of RoHS marking » ROHS  $-\underline{Y}$  ( $\underline{\triangle}$ ) (1) (2)

- (1) RoHS regulation conformity parts.
- (2) MURATA classification number

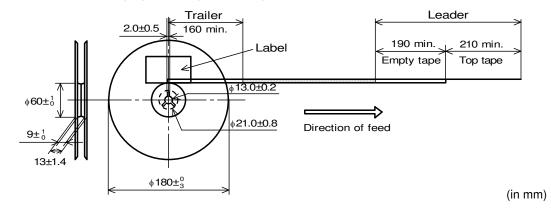
#### (5) Outside package

These reels shall be packed in the corrugated cardboard package and the following items shall be marked on a label and the label is stuck on the box.

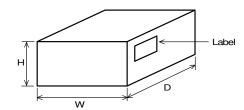
(Customer name, Purchasing Order Number, Customer Part Number, MURATA part number,

RoHS marking (\*2), Quantity, etc)

(6) Dimensions of reel and taping(leader-tape, trailer-tape)



#### 8-4. Specification of Outer Case



Outer Case Dimensions (mm)			Standard Reel Quantity in Outer Case (Reel)
W	D	Н	(Reel)
186	186	93	5

\* Above Outer Case size is typical. It depends on a quantity of an order.

#### 9. 🗥 Caution

#### 9-1.Surge current

Excessive surge current (pulse current or rush current) than specified rated current applied to the product may cause a critical failure, such as an open circuit, burnout caused by excessive temperature rise.

Please contact us in advance in case of applying the surge current.

#### 9-2. Limitation of Applications

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects which might directly cause damage to the third party's life, body or property.

(1)Aircraft equipment (2)Aerospace equipment (3)Undersea equipment

(4)Power plant control equipment (5)Medical equipment (6)Disaster prevention / crime prevention equipment

(7)Traffic signal equipment (8)Transportation equipment (vehicles, trains, ships, etc.)

(9)Applications of similar complexity and /or reliability requirements to the applications listed in the above

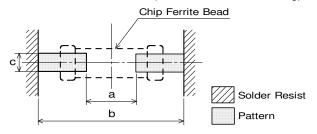
#### 10. Notice

This product is designed for solder mounting.

Please consult us in advance for applying other mounting method such as conductive adhesive.

#### 10-1. Land pattern designing

• Standard land dimensions (Flow and Reflow soldering)



Soldering	а	b	С	
Flow	0.7	2.2 to 2.6	0.7	
Reflow	0.7	1.8 to 2.0	0.7	
			(in mm)	

#### 10-2. Soldering Conditions

Products can be applied to reflow and flow soldering.

(1) Flux, Solder

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	Flux	Use rosin-based flux, but not highly acidic flux (with chlorine content exceeding 0.2(wt)%.)			
		Do not use water-soluble flux.			
	Solder	Use Sn-3.0Ag-0.5Cu solder			
		Standard thickness of solder paste : 100 μm to 200 μm			

#### (2) Soldering conditions

· Pre-heating should be in such a way that the temperature difference between solder and ferrite surface is limited to 150°C max. Also cooling into solvent after soldering should be in such a way that the temperature difference is limited to 100°C max.

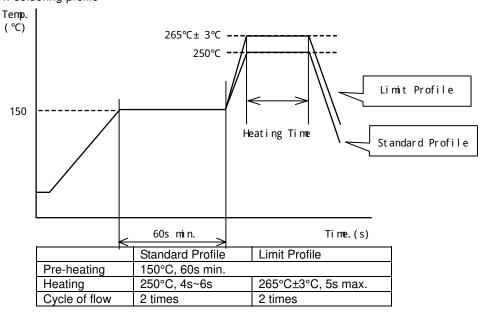
Insufficient pre-heating may cause cracks on the ferrite, resulting in the deterioration of product quality.

• Standard soldering profile and the limit soldering profile is as follows.

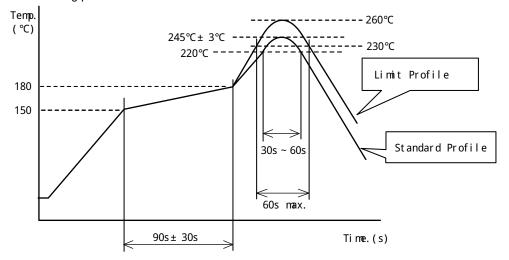
The excessive limit soldering conditions may cause leaching of the electrode and / or resulting in the deterioration

of product quality.

#### □ Flow soldering profile



#### □ Reflow soldering profile



	Standard Profile	Limit Profile
Pre-heating	150°C~180°C, 90s±30s	
Heating	above 220°C, 30s~60s	above 230°C, 60s max.
Peak temperature	245°C±3°C	260°C, 10s
Cycle of reflow	2 times	2 times

#### 10-3. Reworking with soldering iron

• Pre-heating: 150°C, 1 min

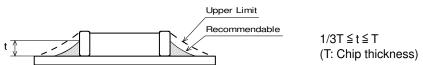
Tip temperature: 350°C max.
Soldering time: 3(+1,-0) seconds.

- Soldering iron output: 80W max.
- Tip diameter:φ 3mm max.
- Times : 2times max.

Note :Do not directly touch the products with the tip of the soldering iron in order to prevent the crack on the ferrite material due to the thermal shock.

#### 10-4. Solder Volume

Solder shall be used not to be exceed as shown below.

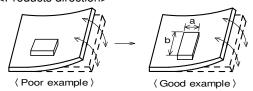


Accordingly increasing the solder volume, the mechanical stress to product is also increased. Exceeding solder volume may cause the failure of mechanical or electrical performance.

#### 10-5. Attention regarding P.C.B. bending

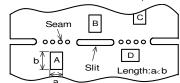
The following shall be considered when designing and laying out P.C.B.'s.

(1) P.C.B. shall be designed so that products are not subject to the mechanical stress for board warpage. <Products direction>



Products shall be located in the sideways direction (Length: a<b) to the mechanical stress.

(2)Products location on P.C.B. separation.



Products (A, B, C, D) shall be located carefully so that products are not subject to the mechanical stress due to warping the board. Because they may be subjected the mechanical stress in order of  $A>C>B \cong D$ .

#### 10-6. Mounting density

Add special attention to radiating heat of products when mounting the inductor near the products with heating. The excessive heat by other products may cause deterioration at joint of this product with substrate.

#### 10-7. Operating Environment

Do not use this product under the following environmental conditions, on deterioration of the Insulation Resistance of the Ferrite material and/or corrosion of Inner Electrode may result from the use.

- (1) in the corrodible atmosphere (acidic gases, alkaline gases, chlorine, sulfur gases, organic gases and etc.)
- (2) in the atmosphere where liquid such as organic solvent, may splash on the products.
- (3) in the atmosphere where the temperature / humidity changes rapidly and it is easy to dew.

#### 10-8. Resin coating

The impedance value may change and/or it may affect on the product's performance due to high cure-stress of resin to be used for coating / molding products. So please pay your careful attention when you select resin. In prior to use, please make the reliability evaluation with the product mounted in your application set.

#### 10-9. Cleaning Conditions

Products shall be cleaned on the following conditions.

- (1)Cleaning temperature shall be limited to 60°C max. (40°C max. for IPA)
- (2)Ultrasonic cleaning shall comply with the following conditions, avoiding the resonance phenomenon at the mounted products and P.C.B.

Power: 20W/I max. Frequency: 28kHz to 40kHz Time: 5 min max.

(3)Cleaner

- 1.Cleaner
  - •Isopropyl alcohol (IPA)
- 2.Aqueous agent
  - ●PINE ALPHA ST-100S
- (4) There shall be no residual flux and residual cleaner after cleaning.

In the case of using aqueous agent, products shall be dried completely after rinse with de-ionized water in order to remove the cleaner.

(5)Other cleaning

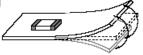
Please contact us.

#### 10-10. Handling of a substrate

After mounting products on a substrate, do not apply any stress to the product caused by bending or twisting to the substrate when cropping the substrate, inserting and removing a connector from the substrate or tightening screw to the substrate.

Excessive mechanical stress may cause cracking in the product.

Bending



Twisting



#### 10-11. Storage Conditions

(1)Storage period

Use the products within 6 months after delivered.

Solderability should be checked if this period is exceeded.

(2)Storage conditions

• Products should be stored in the warehouse on the following conditions.

Temperature : -10°C to 40°C

Humidity : 15% to 85% relative humidity

No rapid change on temperature and humidity

- Don't keep products in corrosive gases such as sulfur, chlorine gas or acid, or it may cause oxidization of electrode, resulting in poor solderability.
- Products should be stored on the palette for the prevention of the influence from humidity, dust and so on.
- Products should be stored in the warehouse without heat shock, vibration, direct sunlight and so on.
- Products should be stored under the airtight packaged condition.

(3)Delivery

Care should be taken when transporting or handling product to avoid excessive vibration or mechanical shock.

#### 11 🗥 Notes

- (1) Please make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.
- (2) You are requested not to use our product deviating from the reference specifications.
- (3) The contents of this reference specification are subject to change without advance notice. Please approve our product specifications or transact the approval sheet for product specifications before ordering.